

BAREBONE

XPC slim

DH610V2_Bundle_8GB



LIMITED-TIME PROMOTIONAL OFFER:

1.3-LITRE BAREBONE PC DH610V2 BUNDLED WITH 8GB RAM *)

The Shuttle XPC slim Barebone DH610V2 with H610 chipset houses the performance of Intel's 12th/13th/14th generation Core desktop processors (codenamed Alder Lake-S and Raptor Lake-S [Refresh]) for socket LGA1700 in a compact 1.3-litre format. The DH610V2 allows for three Ultra HD displays to be operated at the same time via 1x HDMI and 2x DisplayPort. It also offers Dual Intel LAN (one supports 2.5G speed), eight USB ports and two COM ports. The slim metal chassis comes with a VESA mount included, provides versatile connectivity and reliable operation in environments with ambient temperatures of up to 50 °C. This platform is targeted at professional applications such as Digital Signage, POS, POI, gambling machines, office, healthcare and industry.

*) This bundle is available for a limited time and while supplies last



8 GB DDR5 included



1x HDMI 2.0b



2x DISPLAY-PORT 1.4



TRIPLE 4K UHD



NVMe SSD SUPPORT



2.5" HDD/SSD SUPPORT



DUAL LAN (1x 2.5 Gbps)



DUAL COM



VESA MOUNT



WLAN / LTE OPTIONAL



Max. 50 °C



24/7 SUPPORT

SLIM DESIGN

■ Slim 1.35-litre metal chassis, black ■ Dimensions: 190 x 165 x 43 mm (LWH) ■ Including VESA mount (75/100 mm) ■ Supports 24/7 Nonstop Operation ■ Operating temperature: 0~50 °C (non-condensing)

OPERATING SYSTEM

■ An operating system is not included
■ Supports Windows 10, Windows 11 and Linux (64-bit)

PROCESSOR SUPPORT

■ Socket LGA1700 supports Intel Core i9/i7/i5/i3, Pentium Gold und Celeron processors Gen. 12/13/14 ("Alder Lake-S" and "Raptor Lake-S [Refresh]"), max. 65W TDP ■ Includes heatpipe cooling system

GRAPHICS

■ Integrated Intel HD graphics, 4K support (features depend on processor) ■ Supports three independent UHD displays

CHIPSET

■ Intel H610 Chipset

RAM MEMORY

■ 8 GB DDR5 RAM SO-DIMM module included

STORAGE – SATA / M.2

■ 1x 2.5" bay for SATA hard disk or SSD
■ 1x M.2-2280M slot (supports PCIe 3.0 x4 NVMe or SATA)
■ 1x M.2-2230E for optional WLAN module

CONNECTORS

■ 1x HDMI 2.0b ■ 2x DisplayPort 1.4 ■ optional VGA ■ 2x audio (line out, mic) ■ 4x USB 3.2 Gen1 (1x Type-C) ■ 4x USB 2.0 ■ 2x RJ45 LAN-Ports (Intel 1G + 2.5G) ■ 2x COM port (1x RS232/422/485) ■ Connector for external power button ■ "Always on" Jumper

POWER SUPPLY

■ External 120W/19V power adapter ■ DC-Input also support 12V

OPTIONAL ACCESSORIES

■ WLAN Module (WLN-M1 (Wi-Fi 6)/WLN-M12 (Wi-Fi6E))
■ Vertical Stand (PS02) ■ VGA Port (PVG01) ■ Rackmount kit (PRM01)
■ DIN-Rail mounting kit (DIR01) ■ LTE-kit (WWN03)
■ Cable for external power button (CXP01)



Special Offer-Products with 8GB RAM included

Product Name	Volumen	Processor or CPU Socket	Cooling System	DDR5 RAM Module	EAN Bar Code
DS50U_Bundle_8GB	1.3-litre	Intel Celeron 7305 (Intel Core Gen 12)	Heat-pipe without fan	8 GB RAM included	4046047104543
DS50U5_Bundle_8GB	1.3- litre	Intel Core i5-1335U (Intel Core Gen 13)	Heat-pipe without fan	8 GB RAM included	4046047104550
DH610V2_Bundle_8GB	1.3- litre	Socket-1700 for Intel Core Gen 12-14	Heat-pipe with fan	8 GB RAM included	4046047104567
DH810_Bundle_8GB	1.3- litre	Socket-1851 for Intel Core Ultra 2xx	Heat-pipe with fan	8 GB RAM included	4046047104574
XH810_Bundle_8GB	3.5- litre	Socket-1851 for Intel Core Ultra 2xx	Heat-pipe with fan	8 GB RAM included	4046047104581

PRODUCT FEATURES

1.3 L



Only 4.3 cm tall

Robust, stylish and particularly small

You should have held it in your own hands to see how small it actually is. At barely a volume of 1.35 litres, its steel chassis gives it the appropriate stability required for professional applications such as digital signage. Despite its dimensions of 19 x 16.5 x 4.3 cm (LWH), the overall system performance is very high thanks to support of Intel Core desktop processors. The interior of the DH610V2 is very tidy too so that it won't take long to set up. Its sleek and stylish looks let it easily find a place in both home and office environments.



Dual Network (Intel 1G + 2.5G)

The Shuttle XPC slim Barebone DH610V2 supports Dual LAN with Intel network adapters, which are popular for their excellent performance and driver compatibility and are the preferred choice for professional environments. One LAN port even supports up to 2.5Gbps over your existing Cat5e or better cabling. With DH610V2 you can expand your network's bandwidth and reduce digital bottlenecks.

VESA mount

The supplied 75/100mm VESA mount allows for installation on to walls or monitors which is particularly interesting for the industry segment, company buildings and public institutions. Other than this, the chassis bears numerous threaded holes (M3) enabling it to be fitted almost anywhere.



Power on after Power fail

The BIOS setup provides a "Power-On after Power Fail" function that can be found under "Power Management Configuration". As the name indicates, this function determines the PC's behaviour after power failure: (1) unconditional power on, (2) restore former status (3) keep system turned off (4) Power-On by LAN or (5) Power-On by Real-Time-Clock. As a matter of the nature of this function, it may fail after short power failures. This is why the DH610V2 also comes with a hardware-based solution. By removing Jumper JP2 (see image) the system will start unconditionally once power is applied.



Low noise thanks to heatpipe cooling system

An active dual-fan heatpipe cooling system ensures whisper-quiet operation and system stability.



Supports extended temperature range and 24/7 operation

The Shuttle XPC slim Barebone DH610V2 is officially approved for 24/7 permanent operation. Thanks to its efficient cooling, this PC runs highly reliably making it perfectly suitable for digital signage and POI/POS applications - even at ambient temperatures of up to 50 °C (non-condensing).

Caution: For high ambient temperatures over 40 °C we strongly recommend to use SSDs.



Supports Socket LGA1700

Intel® Core™ processors

"Alder Lake-S" / "Raptor Lake-S (Refresh)" is the codename for Intel's 12th/13th/14th Generation of Intel® Core™ Desktop Processors for socket LGA1700 introduced along with the 600/700-Series chipsets. The 12000/13000/14000 series processors feature a new hybrid design combining a number of performance cores (P-cores) and efficiency cores (E-cores). Get the performance you need, where you need it - whether you're a gamer, creator, streamer, or everyday user.



External power button by separate remote line

If, because of space constraints (e.g. in case of fixed installation), the machine cannot be switched on by pressing the front power button, it can be powered on by a separate remote line. You will find an appropriate four-pin connector at the back panel of the DH610V2 (pitch 2.54 mm). Furthermore, this connector provides a Clear CMOS function and +5V DC voltage supply for external devices.

+5V voltage (2) (4) Power Button
Clear CMOS (1) (3) Ground



Triple 4K Display support

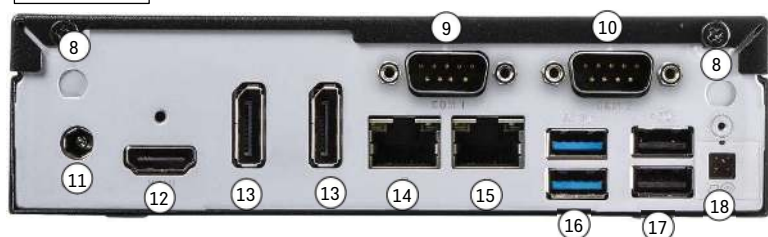
The DH610V2 features three digital video outputs: one HDMI 2.0b and two DisplayPorts (DP 1.4) which all can run at 4K (3840 x 2160 / 2160p) high resolution at 60 Hz frames per second. Furthermore, the DH610V2 supports an optional D-Sub/VGA port. The PC supports a maximum of three displays.

Front and Back Panel

Front panel



Back panel



Right side



1. Microphone input
2. Headphones output
3. LED indicator for power state
4. LED indicator for storage activity
5. Power button
6. 2x USB 3.2 Gen 1 port (1x Type-C)
7. 2x USB 2.0
8. 2x WLAN perforation
9. COM 1 port supports RS232/RS422/RS485
10. COM 2 port supports RS232 (or optional VGA port for analog displays)
11. DC-in connector for power adapter
12. 1x HDMI 2.0b port
13. 2x DisplayPort 1.4
14. RJ45 2.5G LAN port
15. RJ45 Gigabit LAN port
16. 2x USB 3.2 Gen 1 port
17. 2x USB 2.0
18. 4-pin connector (2.54 mm pitch) for external power button, Clear CMOS button and 5V DC voltage

19. Threaded holes (M3)
20. 2x hole for Kensington Lock



21. VESA mount (two parts)

REQUIRED COMPONENTS

The following components need to be added to make it a fully-configured Mini PC

Shuttle XPC slim Barebone DH610V2



LGA1700 Processor

Intel Core Gen 12/13/14 "Alder Lake-S" or "Raptor Lake-S [Refresh]" Core i9 / i7 / i5 / i3, Pentium Gold or Celeron TDP max. 65 W



Memory Modules

Up to two DDR5-5600 (or higher clock rate) SO-DIMM memory modules max. 48 GB each (with Gen12 CPU only max. 32 GB each)



M.2 SSD

M.2-2280 SSD card with SATA or PCIe/NVMe interface



2.5" Storage Drive

SATA hard disk or Solid State Disk (SSD) (max. height: 12.5 mm)



Operating System

Windows 10/11 or Linux (64-bit only)

OPTIONAL ACCESSORIES FROM SHUTTLE



VGA port adapter **PVG01**

Installing PVG01 means one serial port (COM) less can be used on the back panel.



Vertical Stand **PS02**

for vertical operation



WLAN-Accessory

WLN-M1 (802.11ax / Wifi 6)
WLN-M12 (802.11ax / Wifi 6E)
M.2-2230 card supports WLAN and Bluetooth including 2 antennas



DIN-Rail Kit **DIR01**

This mounting kit allows the installation on a standard 35 mm DIN-Rail



LTE Adapter Kit **WWN03**

allows the installation of an M.2 LTE card and nano SIM card (occupies the 2.5" bay)



Rack Mount Kit **PRM01**

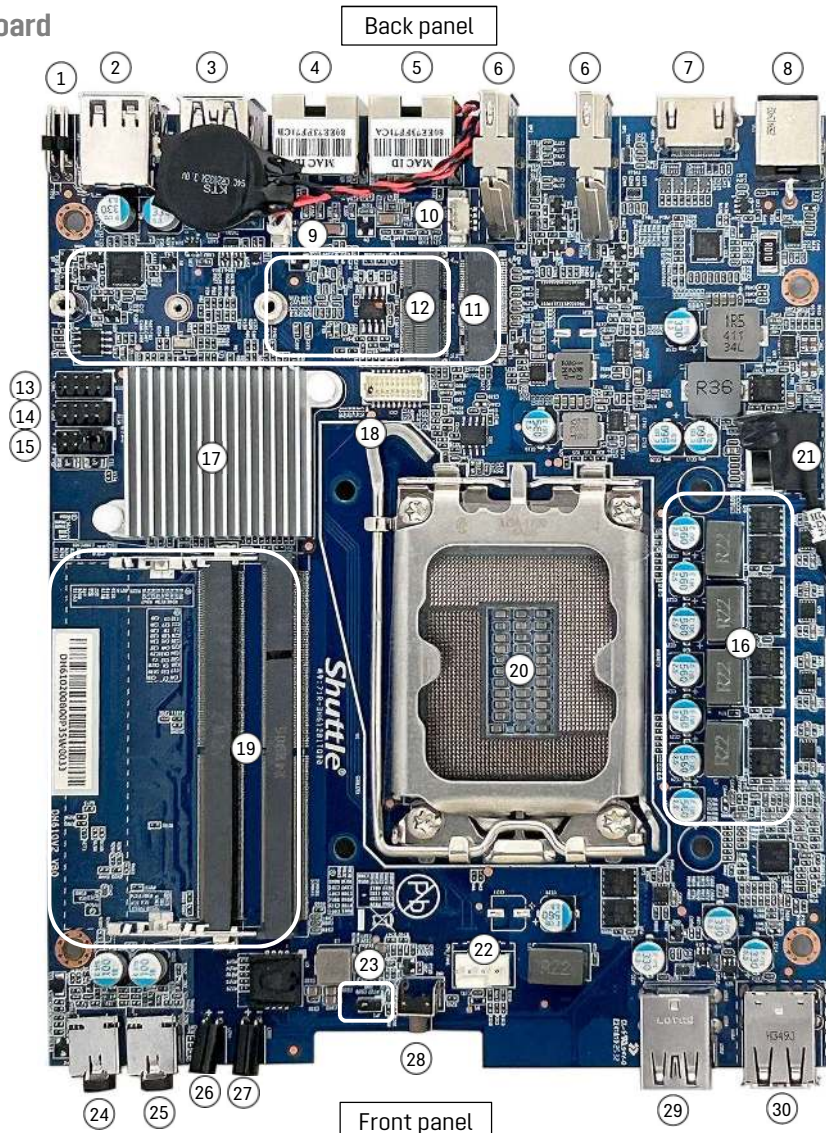
2U front plate to install two 1.3L Shuttle XPCs in a 19" cabinet.



Cable **CXP01**

Cable for external push button switch (without button)

Mainboard



Back panel

Back view



Front view



1. 4-pin connector (2.54 mm pitch) for external power button, Clear CMOS button and 5V DC voltage
2. 2x USB 2.0 port
3. 2x USB 3.2 Gen 1 port
4. RJ45 1.0G LAN port
5. RJ45 2.5G LAN port
6. 2x DisplayPort 1.4
7. HDMI 2.0b port
8. DC-in connector for power adapter
9. Connector for CMOS battery
10. Onboard USB 2.0 connector (4-pin)
11. M.2-2280M slot for SSD card
12. M2-2230E slot for WLAN card
13. Onboard COM 1 port supports RS232/RS422/RS485
14. Onboard COM 2 port supports RS232
15. Jumper for COM 1/2 auxiliary voltage setting (0/5/12 V)
16. CPU Voltage Regulator
17. Intel H610 chipset with heat sink
18. Onboard VGA connector
19. 2x SO-DIMM slot for DDR5 memory
20. LGA1700 processor socket
21. SATA v3.0 connector
22. 4-pin connector for cooling fan
23. Always-Power-On Jumper (JP1)
24. Microphone input
25. Headphones output
26. LED indicator for power state
27. LED indicator for storage activity
28. Power button
29. 2x USB 3.2 Gen 1 port (1x Type-C)
30. 2x USB 2.0 port

Shuttle Product Comparison: DH6xx versus DH770

MODEL	DH610S	DH610	DH610V2	DH670	DH670V2	DH770
PROCESSOR SUPPORT	Intel Core, Socket LGA1700, TDP max. 65 W Codename "Alder Lake-S"/"Raptor Lake [Refresh]-S" – Gen 12/13/14					
CHIPSET	Intel H610	Intel H610	Intel H610	Intel H670	Intel H670	Intel H770
OS SUPPORT	Windows 10/11 and Linux (64-bit)					
MULTI-DISPLAY	max. 2 *)	max. 3	max. 3	max. 4	max. 4	max. 4
RAM MEMORY	max. 2x 32 GB DDR4-3200/2666 SO-DIMM (260p)		max. 2x 32 GB **) DDR5-5600 SO-DIMM (262p)	max. 2x 32 GB DDR4-3200/2666 SO-DIMM (260p)		max. 2x 32 GB **) DDR5-5600 SO-DIMM (262-pin)
2.5" BAY	1x 2.5" drive bay, SATA connector, max. height 12.5 mm					
M.2-2280 SSD SLOT	supports PCIe 3.0 x4 or SATA			supports PCIe 4.0 x4 or SATA		
WLAN SLOT	M.2-2230E					
BUTTONS / LEDS	Power-Button, Power LED, HDD LED					
SD CARD READER	No	No	No	Yes	No	No
GRAPHICS PORTS	HDMI 2.0b DP 1.4	HDMI 2.0b 2x DP 1.4	HDMI 2.0b 2x DP 1.4	2x HDMI 2.0b 2x DP 1.4	2x HDMI 2.0b 2x DP 1.4	2x HDMI 2.0b 2x DP 1.4
USB 3.2 GEN. 2	—	—	—	4	4	4
USB 3.2 GEN. 1	4 (1x Type-C)	4 (1x Type-C)	4 (1x Type-C)	4 (1x Type-C)	4 (1x Type-C)	4 (1x Type-C)
USB 2.0	4	4	4	—	—	—
COM PORTS	—	2	2	2	2	2
GIGABIT NETWORK	Single LAN Intel 219V/LM (1G)	Dual LAN Intel 225 (2.5G) Intel 219V/LM (1G)	Dual LAN Intel 225 (2.5G) Intel 219V/LM (1G)	Dual LAN Intel 210 (1G) Intel 211 (1G)	Dual LAN Intel 225 (2.5G) Intel 225 (2.5G)	Dual LAN Intel 226LM (2.5G) Intel 226LM (2.5G)
AUDIO		Mic-Input, Line-Out (Realtek ALC662/897/888S)				... ALC888S
OPTIONAL ACCESSORIES	WLAN Kit (WLN-M1/M12), Vertical Stand (PS02), Rackmount Kit (PRM01), VGA Port (PVG01) Power Button Cable (CXP01), DIN-Rail Mount (DIR01), LTE-Kit (WWN03)					
VESA MOUNT	optional PV04	supplied	supplied	supplied	supplied	supplied
POWER ADAPTER	120 W / 19 V					
DC-IN 12V SUPPORT	—	Yes	Yes	—	—	—

Product Images



*) The DH610S supports 3 displays, if equipped with VGA port (accessory PVG01)

**) DH610V2 and DH770 supports max. 2x 48 GB DDR5 RAM in combination with a Gen13/14 "Raptor Lake" processor

SHUTTLE XPC SLIM BAREBONE DH610V2_Bundle_8GB — SPECIFICATIONS

CHASSIS	Slim PC with black chassis made of metal Dimensions: 190 x 165 x 43 mm (LWH) = 1.35-litre Weight: 1.3 kg net and 2.1 kg gross Two holes for Kensington Locks and numerous threaded holes (M3) on both sides of the chassis
POWER ADAPTER	External 120 W power adapter (fanless) Input: 100~240 V AC, 50/60 Hz Output: 19 V DC, 6.32 A, max. 120 W DC Connector: 5.5/2.5 mm (outer/inner diameter) Remark: The DC-input of the computer supports an external power source with 19V±5% or 12V±5%. AC mains cable: 3 pins, ca. 1.7 m length, with C5/C6 coupler (called "Mickey Mouse" or "Clover-leaf") for the power adapter and CEE-7/7 plug with earth-contact (type E+F) for the power outlet
OPERATING SYSTEM	This system comes without an operating system. It is compatible with Windows 10/11 and Linux (64-bit).
PROCESSOR SUPPORT	Processor Socket LGA1700 Supports Intel Core i9 / i7 / i5 / i3, Pentium Gold and Celeron processors Supports the following generations of Intel Core processors: - Gen 12 "Alder Lake-S" - Gen 13 "Raptor Lake-S" - Gen 14 "Raptor Lake-S Refresh" in "Intel 7" process technology (previously Intel 10 nm Enhanced SuperFin) Supports processors with integrated graphics only [5] Maximum supported processor power consumption (TDP) = 65 W Does not support the unlock-function of Intel K-Series processors. The processor integrates PCI-Express, memory controller and the graphics engine on the same die.
PROCESSOR COOLING	Heatpipe processor cooling with two 70 mm fans on the upper side of the chassis
MAINBOARD / CHIPSET	Mainboard in a Shuttle form factor proprietary design for the XPC DH610V2 Chipset/Southbridge: Intel® H610 Passive chipset cooling with heat sink The Northbridge is integrated in the processor. Solid Capacitors for sensitive areas provide excellent heat resistance for enhanced system durability.
BIOS	AMI BIOS, SPI Interface, 16 MB Flash-EEPROM Supports Hardware Monitoring and watch dog functionality Supports Firmware-TPM (fTPM) v2.0 [9] Supports boot up from external USB flash memory Supports Unified Extensible Firmware Interface (UEFI) Supports power on after power failure [7]
RAM MEMORY	8 GB DDR5 RAM SO-DIMM module included (The memory module is located in the sealed accessory box.) The PC features two SO-DIMM slots with 262 pins Supports DDR5-5600 (PC5-44800) SDRAM at 1.1 V Supports Dual Channel mode Supports a maximum of 48 GB per DIMM, maximum total size: 96 GB Note: In combination with an Intel Core Gen 12 "Alder Lake" processor RAM modules up to a maximum of 32 GB each are supported. Supports two unbuffered DIMM modules (no ECC or registered)
INTEGRATED GRAPHICS	The features of the integrated Intel UHD graphics function depend on the processor type used. [5] The PC features three video outputs which support 1080p/60 and 2160p/60: - 1x HDMI v2.0b - 2x DisplayPort v1.4 Supports displays with 4K Ultra HD resolution at 3840 x 2160 DisplayPort and HDMI support multi-channel digital audio over the same cable. Optional analog D-Sub/VGA video output [4] Supports three independent displays with the integrated graphics function

DRIVE BAY	1x 6.35 cm / 2.5" storage bay supports one hard disk or SSD drive with SATA connector Device height: 12.5 mm (max.)
SATA CONNECTORS	1x Serial-ATA III, 6 Gb/s (600 MB/s) bandwidth With Serial-ATA power connector (onboard)
M.2-2280M SSD SLOT	The M.2 2280M slot provides the following interfaces: - PCI-Express Gen. 3.0 X4, supports NVMe - SATA v3.0 (max. 6 Gbps) It supports M.2 cards with a width of 22 mm and a length of 80 mm (type 2280). Supports M.2 SSDs with SATA or PCI-Express interface
M.2-2230E SLOT FOR WLAN CARDS	Interfaces: PCI-Express Gen. 2.0 X1 and USB 2.0 Supports M.2 cards with a width of 22 mm and a length of 30 mm (type 2230) Supports WLAN expansion cards (optional Shuttle accessory: WLN-M1/M12)
AUDIO	Audio Realtek® ALC 888S High-Definition Audio Two analog audio connectors (3.5 mm) on the front panel: 1) 2-channel line-out (headphones) 2) microphone input Digital multi-channel audio output: by HDMI and DisplayPort
DUAL LAN CONTROLLER	Dual network with two RJ45 ports with two status LEDs each Used network chips: 1) Intel i226 supports 100 / 1.000 / 2.500 MBit/s data transfer rate 2) Intel 219V/LM supports 10 / 100 / 1.000 MBit/s data transfer rate Supports WAKE ON LAN (WOL) Supports network boot by Preboot eXecution Environment (PXE)
FRONT PANEL CONNECTORS	Microphone input Audio Line-out (headphones) 1x USB 3.2 Gen 1 Type A (blue) 1x USB 3.2 Gen 1 Type C 2x USB 2.0 Type A (black) Power button Power LED (blue) HDD LED (yellow)
BACK PANEL CONNECTORS	1x HDMI 2.0b connector [1] 2x DisplayPort 1.4 connector (DP) [2] Optional: 1x D-Sub VGA connector (Accessory PVG01 [4]) 2x USB 3.2 Gen 1 Type A (blue) 2x USB 2.0 Type A (black) 2x RJ45 LAN Port (1G + 2.5G) 2x RS232 serial port, 9-pin D-Sub (5/12V, 1x RS422/RS485) [3] 1x DC-input connector for external power adapter (supports 19V±5%) 1x 4-pin connector (2.54 mm pitch) supports: - external power on button - Clear CMOS function - +5V DC voltage for external components 2x perforation for optional Wireless LAN antennas 2x hole for Kensington Lock
OTHER ONBOARD CONNECTORS	1x jumper for power-on-after-power-fail (hardware solution) [7] 1x analog VGA graphics output CN6 (2x 10-pin, 1 mm pitch) [4] 2x serial interface (COM) occupied by back panel connectors 1x USB 2.0 (4-pin) for optional accessory WWN03 (LTE kit) 1x fan connector (4-pin) occupied by the cooling system 1x connector for CMOS battery (occupied)

SUPPLIED ACCESSORIES	Multi-language user guide (EN, DE, FR, ES, JP, KR, SC, TC) VESA mount for 75/100 mm standard (two metal brackets) Four screws M3 x 5 mm (screws together VESA mount and PC) Four screws M4 x 10 mm (to affix VESA mount on the PC) Four screws M3 x 4 mm (to mount a 2.5" storage device into the bay) Two screws M3 x 5 mm (silver colour, to mount two M.2 cards) Driver DVD (Windows 64-bit) Serial ATA cable for 2.5" drive including power cable External 120 W power adapter with power cord Protection cap for CPU socket (do not use if heatpipe or fan is mounted) Heatsink compound
OPTIONAL ACCESSORIES	PVG01: optional D-Sub VGA video output [4] WLN-M1/WLN-M12: WLAN module in M.2-2230 format supports WLAN and Bluetooth with two external antennas. WWN03: LTE adapter kit with antennas, but without LTE card [8] PS02: Stand for vertical operation CXP01: adapter cable for external power button PRM01: 2U rack mount front plate for two Shuttle XPC slim PCs DIR01: DIN-Rail mounting kit
ENVIRONMENTAL SPECIFICATIONS	Operating temperature range: 0~50 °C [6] Relative humidity, non-condensing: 10~90 %
CERTIFICATIONS / COMPLIANCE	EMI: FCC, CE, BSMI, RCM, VCCI Safety: ETL, CB, BSMI Other: RoHS, Energy Star, ErP
CONFORMITY	This device is classed as a technical information equipment (ITE) in class B and is intended for use in living room and office. The CE-mark approves the conformity by the EU directives: (1) 2004/108/EC relating to electromagnetic compatibility (EMC), (2) 2006/95/EC relating to Electrical Equipment designed for use within certain voltage limits (LVD), (3) 2009/125/EC relating to ecodesign requirements for energy-related products (ErP)

[1] HDMI output supports DVI-D with optional adapter

[2] How to convert DisplayPort into HDMI/DVI

The DisplayPort output can be converted to HDMI or DVI by an additional, passive adapter cable. For example:

DELOCK 82590: 1 m, DisplayPort (male, 20p) to HDMI-A (male, 19p)

DELOCK 82435: 5 m, DisplayPort (male, 20p) to DVI-D (male, 24p)

The integrated graphics automatically detects the connected display and puts out the appropriate electric signal - either through DisplayPort (without an adapter) or HDMI/DVI (with an adapter).

However, a monitor with a DisplayPort connector cannot be connected to the HDMI port with a simple, passive adapter.

[3] Serial Ports

This PC features two serial RS232 ports with 9-pin D-Sub connectors at the back panel. The left COM port (COM1) can also be configured as RS422 and RS485 in BIOS.

Pin 9 of the D-Sub COM-Port is a multi-functional signal. Based on the Jumper JP1 configuration on the mainboard, it can be configured as Ring Indicator (RI) or external power supply with a voltage level of either 5 V or 12 V. Each COM port can be configured separately. The maximum current is 500 mA per connector.

[4] Optional D-Sub/VGA connector

The mainboard features one analog graphics port CN6 on the mainboard. This signal can be lead to the outside as a 15-pin D-Sub VGA connector on the back panel by using the optional adapter PVG01. However doing so means one serial port (COM) less can be used on the back panel. The integrated graphics supports a maximum of four displays simultaneously.

[5] Intel processors without integrated graphics (ID ends with "F", e.g. Core i7-12700F) are not compatible.

[6] Operating temperature

For high ambient temperatures over 40 °C we strongly recommend to use SSDs (supporting at least 70 °C) and rugged SO-DIMM memory modules with a temperature range of up to 95 °C.

[7] Power on after power fail

The BIOS setup provides a "Power-On after Power Fail" function that can be found under "Power Management Configuration". As the name indicates, this function determines the PC's behaviour after power failure: (1) unconditional power on, (2) restore former status or (3) keep system turned off. As a matter of the nature of this function, it may fail after short power failures. This is why the DH610V2 also comes with a hardware-based solution. By removing Jumper JP2 (on the mainboard behind the power button) the system will start unconditionally once power is supplied.

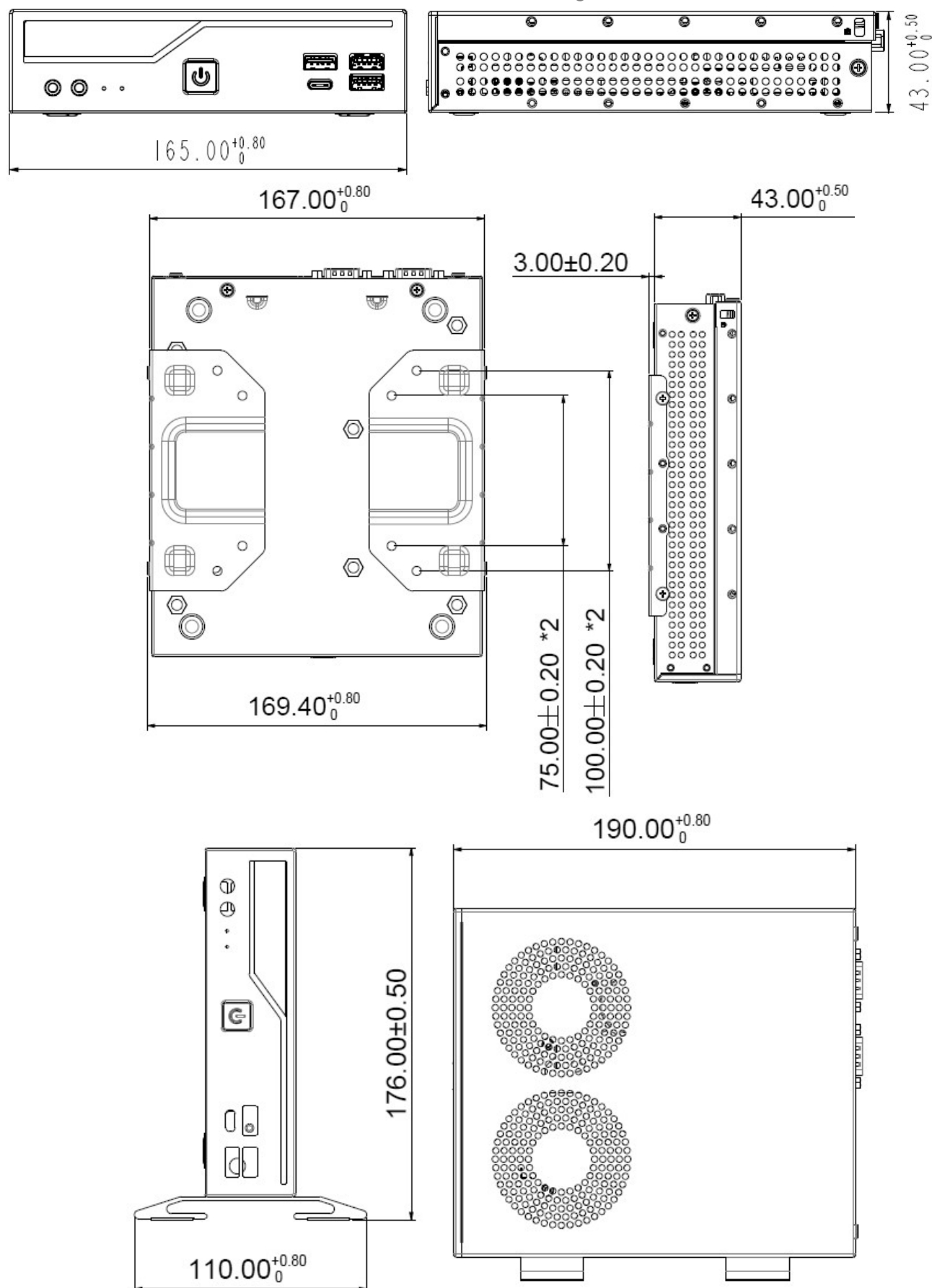
[8] Optional Accessory WWN03 (LTE kit)

The Shuttle XPC accessory WWN03 allows this PC to be upgraded with an LTE/4G function for mobile network. The LTE card will occupy the 2.5" bay, so you will have to use an M.2 SSD as a mass storage device. The required LTE/4G card in M.2-3042 format and an activated Nano SIM card is not included in the scope of delivery.

[9] TPM Function

This product features Firmware-TPM (fTPM) v2.0. Besides this, it is prepared for a hardware TPM chip which can be fitted by factory on request, if required.

SHUTTLE XPC SLIM BAREBONE DH610V2 – Technical Drawing



12TH GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1700 10 nm "Alder Lake S" processor overview (Date: January 2022)

Processors with a TDP of more than 65W and processors without graphics function (ID ends with "F") are **not supported (marked in red)**.

PROCESSOR	MODEL	P-CORES/ THREADS	P-CORES CLOCK/Turbo	E-CORES	E-CORES CLOCK/Turbo	SMART CACHE	BASE TDP	MEMORY SUPPORT	GRAPHICS ENGINE (MAX. CLOCK)
Core™ i9	12900K	8 / 16	3.2 – 5.1 GHz	8	2.4 – 3.9 GHz	30 MB	125 W	DDR5-5600	UHD 770 (1.55 GHz)
	12900KF	8 / 16	3.2 – 5.1 GHz	8	2.4 – 3.9 GHz	30 MB	125 W	DDR5-5600	None
	12900	8 / 16	2.4 – 5.0 GHz	8	1.8 – 3.8 GHz	30 MB	65 W	DDR5-5600	UHD 770 (1.55 GHz)
	12900F	8 / 16	2.4 – 5.0 GHz	8	1.8 – 3.8 GHz	30 MB	65 W	DDR5-5600	None
	12900T	8 / 16	1.4 – 4.8 GHz	8	1.0 – 3.6 GHz	30 MB	35 W	DDR5-5600	UHD 770 (1.55 GHz)
Core™ i7	12700K	8 / 16	3.6 – 4.9 GHz	4	2.7 – 3.8 GHz	25 MB	125 W	DDR5-5600	UHD 770 (1.50 GHz)
	12700KF	8 / 16	3.6 – 4.9 GHz	4	2.7 – 3.8 GHz	25 MB	125 W	DDR5-5600	None
	12700	8 / 16	2.1 – 4.9 GHz	4	1.6 – 3.6 GHz	25 MB	65 W	DDR5-5600	UHD 770 (1.50 GHz)
	12700F	8 / 16	2.1 – 4.9 GHz	4	1.6 – 3.6 GHz	25 MB	65 W	DDR5-5600	None
	12700T	8 / 16	1.4 – 4.6 GHz	4	1.0 – 3.4 GHz	25 MB	35 W	DDR5-5600	UHD 770 (1.50 GHz)
Core™ i5	12600K	6 / 12	3.7 – 4.9 GHz	4	2.8 – 3.6 GHz	20 MB	125 W	DDR5-5600	UHD 770 (1.45 GHz)
	12600KF	6 / 12	3.7 – 4.9 GHz	4	2.8 – 3.6 GHz	20 MB	125 W	DDR5-5600	None
	12600	6 / 12	3.3 – 4.8 GHz	–	–	18 MB	65 W	DDR5-5600	UHD 770 (1.45 GHz)
	12600T	6 / 12	2.1 – 4.6 GHz	–	–	18 MB	35 W	DDR5-5600	UHD 770 (1.45 GHz)
	12500	6 / 12	3.0 – 4.6 GHz	–	–	18 MB	65 W	DDR5-5600	UHD 770 (1.45 GHz)
	12500T	6 / 12	2.0 – 4.4 GHz	–	–	18 MB	35 W	DDR5-5600	UHD 770 (1.45 GHz)
	12400	6 / 12	2.5 – 4.4 GHz	–	–	18 MB	65 W	DDR5-5600	UHD 730 (1.45 GHz)
	12400F	6 / 12	2.5 – 4.4 GHz	–	–	18 MB	65 W	DDR5-5600	None
	12400T	6 / 12	1.8 – 4.2 GHz	–	–	18 MB	35 W	DDR5-5600	UHD 730 (1.45 GHz)
Core™ i3	12300	4 / 8	3.5 – 4.4 GHz	–	–	12 MB	60 W	DDR5-5600	UHD 730 (1.45 GHz)
	12300T	4 / 8	2.3 – 4.2 GHz	–	–	12 MB	35 W	DDR5-5600	UHD 730 (1.45 GHz)
	12100	4 / 8	3.3 – 4.3 GHz	–	–	12 MB	60 W	DDR5-5600	UHD 730 (1.45 GHz)
	12100F	4 / 8	3.3 – 4.3 GHz	–	–	12 MB	58 W	DDR5-5600	None
	12100T	4 / 8	2.2 – 4.1 GHz	–	–	12 MB	35 W	DDR5-5600	UHD 730 (1.40 GHz)
Pentium® Gold	G7400	2 / 4	3.7 GHz	–	–	6 MB	46 W	DDR5-5600	UHD 710 (1.35 GHz)
	G7400T	2 / 4	3.1 GHz	–	–	6 MB	35 W	DDR5-5600	UHD 710 (1.35 GHz)
Celeron®	G6900	2 / 2	3.4 GHz	–	–	4 MB	46 W	DDR5-5600	UHD 710 (1.30 GHz)
	G6900T	2 / 2	2.8 GHz	–	–	4 MB	35 W	DDR5-5600	UHD 710 (1.30 GHz)

K = unlocked, **T** = Power optimized lifestyle, **F** = without integrated graphics, **Base TDP** = Base Thermal Design Power (max. Base Power Consumption).Note: The Shuttle XPC slim Barebone DH610V2 does not support the Unlock-function of Intel K-Series processors.

P-Cores: Performance-Cores, E-Cores: Efficient-Cores

Core Clock: the listed core frequency ranges from Base Frequency to Turbo Frequency (Turbo Boost 3.0 Frequency is not mentioned here)

Base TDP: Processor Base Power dissipation that the processor is validated to not exceed at Base Frequency (Max. Turbo Power is not mentioned here)

Please refer to the support list for detailed processor support information at global.shuttle.com.

13TH GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1700, Intel 7 / 10 nm, "Raptor Lake S" processor overview (Date: January 2023)

Processors with a **TDP of more than 65W** and **processors without graphics function (ID ends with "F")** are not supported (marked in red).

Important note: for Intel Core processors of the generation 13 ("Raptor Lake-S") and generation 14 ("Raptor Lake-S Refresh") a BIOS up-date might be necessary, that need to be performed with a compatible processor.

- Generation 13 is supported since BIOS version 202 (available since March'23 and

- Generation 14 is supported since BIOS version 211 (available since Jan'24).

Download-Website: <https://global.shuttle.com/support/download>.

PROCESSOR	MODEL	P-CORES/ THREADS	P-CORES CLOCK/Turbo	E-CORES	E-CORES CLOCK/Turbo	SMART CACHE	BASE TDP	MEMORY SUPPORT	GRAPHICS ENGINE (MAX. CLOCK)
Core™ i9	13900KS	8 / 16	3.2 – 6.0 GHz	16	2.4 – 4.3 GHz	36 MB	150 W	DDR5-5600	UHD 770 (1.65 GHz)
	13900K	8 / 16	3.0 – 5.8 GHz	16	2.0 – 4.3 GHz	36 MB	125 W	DDR5-5600	UHD 770 (1.65 GHz)
	13900KF	8 / 16	3.0 – 5.8 GHz	16	2.0 – 4.3 GHz	36 MB	125 W	DDR5-5600	None
	13900	8 / 16	2.0 – 5.2 GHz	16	1.5 – 4.2 GHz	36 MB	65 W	DDR5-5600	UHD 770 (1.65 GHz)
	13900F	8 / 16	2.0 – 5.2 GHz	16	1.5 – 4.2 GHz	36 MB	65 W	DDR5-5600	None
	13900T	8 / 16	1.1 – 5.1 GHz	16	0.8 – 3.9 GHz	36 MB	35 W	DDR5-5600	UHD 770 (1.65 GHz)
Core™ i7	13700K	8 / 16	3.4 – 5.4 GHz	8	2.5 – 4.2 GHz	30 MB	125 W	DDR5-5600	UHD 770 (1.60 GHz)
	13700KF	8 / 16	3.4 – 5.4 GHz	8	2.5 – 4.2 GHz	30 MB	125 W	DDR5-5600	None
	13700	8 / 16	2.1 – 5.1 GHz	8	1.5 – 4.1 GHz	30 MB	65 W	DDR5-5600	UHD 770 (1.60 GHz)
	13700F	8 / 16	2.1 – 5.1 GHz	8	1.5 – 4.1 GHz	30 MB	65 W	DDR5-5600	None
	13700T	8 / 16	1.4 – 4.8 GHz	8	1.0 – 3.6 GHz	30 MB	35 W	DDR5-5600	UHD 770 (1.60 GHz)
Core™ i5	13600K	6 / 12	3.5 – 5.1 GHz	8	2.6 – 3.9 GHz	20 MB	125 W	DDR5-5600	UHD 770 (1.50 GHz)
	13600KF	6 / 12	3.5 – 5.1 GHz	8	2.6 – 3.9 GHz	20 MB	125 W	DDR5-5600	None
	13600	6 / 12	2.7 – 5.0 GHz	8	2.0 – 3.7 GHz	24 MB	65 W	DDR5-5600	UHD 770 (1.55 GHz)
	13600T	6 / 12	1.8 – 4.8 GHz	8	1.3 – 3.4 GHz	24 MB	35 W	DDR5-5600	UHD 770 (1.55 GHz)
	13500	6 / 12	2.5 – 4.8 GHz	8	1.8 – 3.5 GHz	24 MB	65 W	DDR5-5600	UHD 770 (1.55 GHz)
	13500T	6 / 12	1.6 – 4.6 GHz	8	1.2 – 3.2 GHz	24 MB	35 W	DDR5-5600	UHD 770 (1.55 GHz)
	13400	6 / 12	2.5 – 4.6 GHz	4	1.8 – 3.3 GHz	20 MB	65 W	DDR5-5600	UHD 730 (1.55 GHz)
	13400F	6 / 12	2.5 – 4.6 GHz	4	1.8 – 3.3 GHz	20 MB	65 W	DDR5-5600	None
Core™ i3	13400T	6 / 12	1.3 – 4.4 GHz	4	1.0 – 3.0 GHz	20 MB	35 W	DDR5-5600	UHD 730 (1.55 GHz)
	13100	4 / 8	3.4 – 4.5 GHz	–	–	12 MB	60 W	DDR5-5600	UHD 730 (1.50 GHz)
	13100F	4 / 8	3.4 – 4.5 GHz	–	–	12 MB	58 W	DDR5-5600	None
	13100T	4 / 8	2.5 – 4.2 GHz	–	–	12 MB	35 W	DDR5-5600	UHD 730 (1.50 GHz)

K = unlocked, **T** = Power optimized lifestyle, **F** = without integrated graphics, Base TDP = Base Thermal Design Power (max. Base Power Consumption).

Note: The Shuttle XPC slim Barebone DH610V2 does not support the Unlock-function of Intel K-Series processors.

P-Cores: Performance-Cores, E-Cores: Efficient-Cores

Core Clock: the listed core frequency ranges from Base Frequency to Turbo Frequency (Turbo Boost 3.0 Frequency is not mentioned here)

Base TDF: Processor Base Power dissipation that the processor is validated to not exceed at Base Frequency (Max. Turbo Power is not mentioned here)

Please refer to the support list for detailed processor support information at global.shuttle.com.

14TH GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1700, Intel 7 / 10 nm, "Raptor Lake S Refresh" processor overview (Date: January 2024)

Processors with a **TDP of more than 65W** and **processors without graphics function (ID ends with "F")** are not supported (marked in red).

PROCESSOR	MODEL	P-CORES/ THREADS	P-CORES CLOCK/Turbo	E-CORES	E-CORES CLOCK/Turbo	SMART CACHE	BASE TDP	MEMORY SUPPORT	GRAPHICS ENGINE (MAX. CLOCK)
Core™ i9	14900K	8 / 16	3.2 – 5.6 GHz	16	2.4 – 4.4 GHz	36 MB	125 W	DDR5-5600	UHD 770 (1.65 GHz)
	14900KF	8 / 16	3.2 – 5.6 GHz	16	2.4 – 4.4 GHz	36 MB	125 W	DDR5-5600	None
	14900	8 / 16	2.0 – 5.4 GHz	16	1.5 – 4.3 GHz	36 MB	65 W	DDR5-5600	UHD 770 (1.65 GHz)
	14900F	8 / 16	2.0 – 5.4 GHz	16	1.5 – 4.3 GHz	36 MB	65 W	DDR5-5600	None
	14900T	8 / 16	1.1 – 5.1 GHz	16	0.8 – 4.0 GHz	36 MB	35 W	DDR5-5600	UHD 770 (1.65 GHz)
Core™ i7	14700K	8 / 16	3.4 – 5.6 GHz	8	2.5 – 4.3 GHz	33 MB	125 W	DDR5-5600	UHD 770 (1.60 GHz)
	14700KF	8 / 16	3.4 – 5.6 GHz	8	2.5 – 4.3 GHz	33 MB	125 W	DDR5-5600	None
	14700	8 / 16	2.1 – 5.3 GHz	8	1.5 – 4.2 GHz	33 MB	65 W	DDR5-5600	UHD 770 (1.60 GHz)
	14700F	8 / 16	2.1 – 5.4 GHz	8	1.5 – 4.2 GHz	33 MB	65 W	DDR5-5600	None
	14700T	8 / 16	1.3 – 5.0 GHz	8	0.9 – 3.7 GHz	33 MB	35 W	DDR5-5600	UHD 770 (1.60 GHz)
Core™ i5	14600K	6 / 12	3.5 – 5.3 GHz	8	2.6 – 4.0 GHz	24 MB	125 W	DDR5-5600	UHD 770 (1.50 GHz)
	14600KF	6 / 12	3.5 – 5.3 GHz	8	2.6 – 4.0 GHz	24 MB	125 W	DDR5-5600	None
	14600	6 / 12	2.7 – 5.2 GHz	8	2.0 – 3.9 GHz	24 MB	65 W	DDR5-5600	UHD 770 (1.55 GHz)
	14600T	6 / 12	1.8 – 5.1 GHz	8	1.3 – 3.6 GHz	24 MB	35 W	DDR5-5600	UHD 770 (1.55 GHz)
	14500	6 / 12	2.6 – 5.0 GHz	8	1.9 – 3.7 GHz	24 MB	65 W	DDR5-5600	UHD 770 (1.55 GHz)
	14500T	6 / 12	1.7 – 4.8 GHz	8	1.2 – 3.4 GHz	24 MB	35 W	DDR5-5600	UHD 770 (1.55 GHz)
	14400	6 / 12	2.5 – 4.7 GHz	4	1.8 – 3.5 GHz	20 MB	65 W	DDR5-5600	UHD 730 (1.55 GHz)
	14400F	6 / 12	2.5 – 4.7 GHz	4	1.8 – 3.5 GHz	20 MB	65 W	DDR5-5600	None
	14400T	6 / 12	1.5 – 4.5 GHz	4	1.1 – 3.2 GHz	20 MB	35 W	DDR5-5600	UHD 730 (1.55 GHz)
Core™ i3	14100	4 / 8	3.5 – 4.7 GHz	–	–	12 MB	60 W	DDR5-5600	UHD 730 (1.50 GHz)
	14100F	4 / 8	3.5 – 4.7 GHz	–	–	12 MB	58 W	DDR5-5600	None
	14100T	4 / 8	2.7 – 4.4 GHz	–	–	12 MB	35 W	DDR5-5600	UHD 730 (1.50 GHz)

K = unlocked, **T** = Power optimized lifestyle, **F** = without integrated graphics, **Base TDP** = Base Thermal Design Power (max. Base Power Consumption).Note: The Shuttle XPC slim Barebone DH610V2 does not support the Unlock-function of Intel K-Series processors.

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